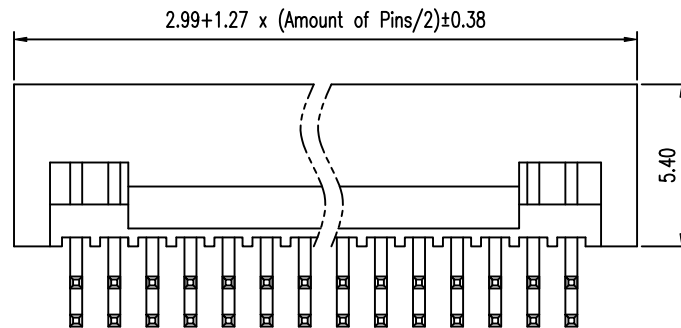
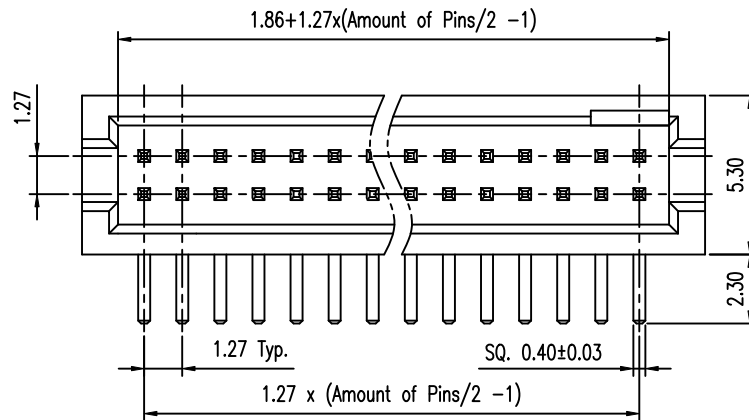
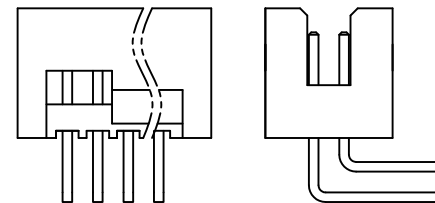
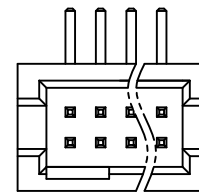
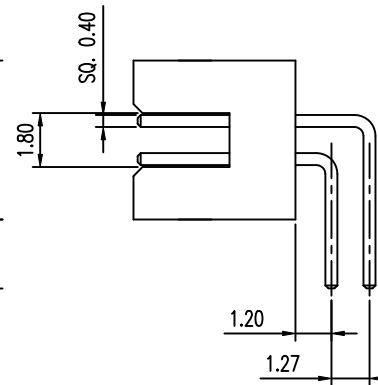


Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm



APPEARANCE OF 20021212

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03mm
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021212 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

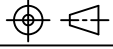
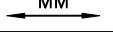
- 1: GOLD FLASH, ALL OVER
- 4: 0.25um(10U")GOLD AT CONTACT
- 8: 0.76um(30U")GOLD AT CONTACT

PACKING

T: TUBE

PIN COUNT

- 06,08,10,...98,A0
- (6 - 100 EVERY EVEN PIN)
- EXCEPT 18,22,24,28,32,36,38
- 42,46,48,52,54,56,58,62
- 70 TO 78,82 TO 98 POS.

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	 www.fciconnect.com	
ltr	ecn no	dr	date	linear	angles			
A	T09-1117	S.LIN	09/15/09	.X ± 0.38		projection	 title 1.27X1.27MM BTB,HEADER SHROUDED,RIGHT ANGLE, TH	
B	T10-0016	S.LIN	01/21/10	.XX ± 0.25				
				.XXX ± 0.10	0° $\pm 2^\circ$		 product family 585 size dwg no	
				dr	STERLING LIN	09/15/09	 scale NA A4	
				engr	STERLING LIN	09/15/09		
				chr	GARY HSIEH	09/15/09	 20021212 code TWN sheet 1 of 1	
				appd	JOSEPH HSIA	09/15/09		
sheet index	revision sheet	B	1					